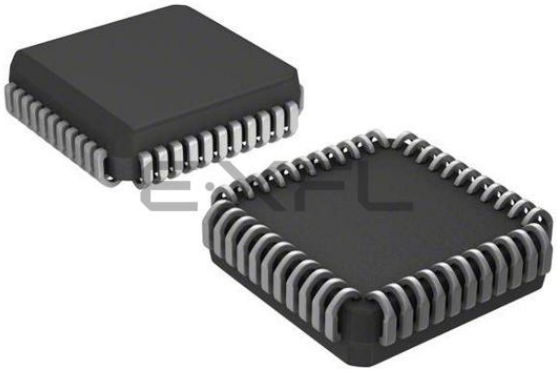


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

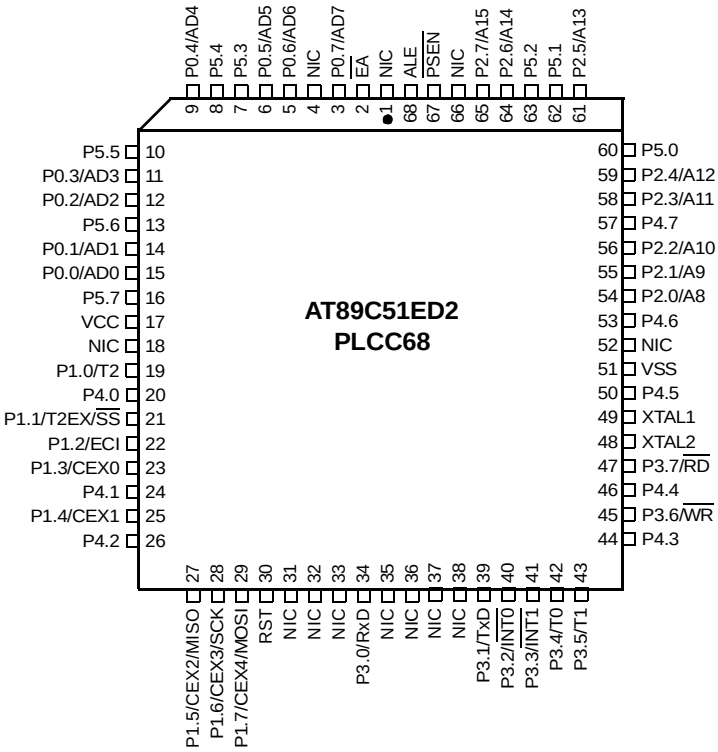
Details	
Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	60MHz
Connectivity	SPI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	34
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LCC (J-Lead)
Supplier Device Package	44-PLCC (16.6x16.6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at89c51ed2-slrim

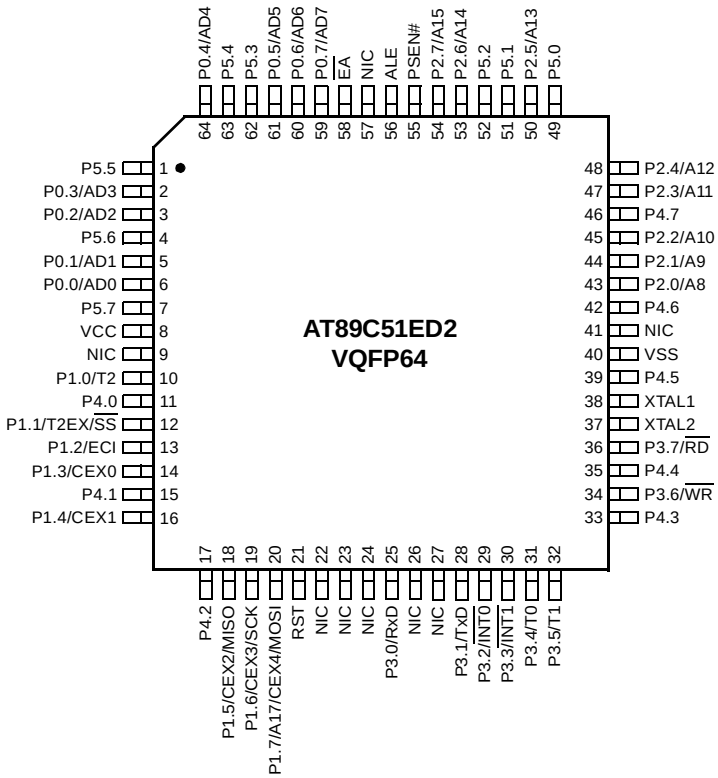
Table 12 shows all SFRs with their address and their reset value.

Table 12. SFR Mapping

	Bit Addressable	**Non Bit Addressable**							
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	
F8h		CH 0000 0000	CCAP0H XXXX XXXX	CCAP1H XXXX XXXX	CCAP2H XXXX XXXX	CCAP3H XXXX XXXX	CCAP4H XXXX XXXX		FFh
F0h	B 0000 0000								F7h
E8h	P5 bit addressable 1111 1111	CL 0000 0000	CCAP0L XXXX XXXX	CCAP1L XXXX XXXX	CCAP2L XXXX XXXX	CCAP3L XXXX XXXX	CCAP4L XXXX XXXX		EFh
E0h	ACC 0000 0000								E7h
D8h	CCON 00X0 0000	CMOD 00XX X000	CCAPM0 X000 0000	CCAPM1 X000 0000	CCAPM2 X000 0000	CCAPM3 X000 0000	CCAPM4 X000 0000		DFh
D0h	PSW 0000 0000	FCON XXXX 0000	EECON xxxx xx00						D7h
C8h	T2CON 0000 0000	T2MOD XXXX XX00	RCAP2L 0000 0000	RCAP2H 0000 0000	TL2 0000 0000	TH2 0000 0000			CFh
C0h	P4 1111 1111			SPCON 0001 0100	SPSTA 0000 0000	SPDAT XXXX XXXX		P5 byte Addressable 1111 1111	C7h
B8h	IPL0 X000 000	SADEN 0000 0000							BFh
B0h	P3 1111 1111	IEN1 XXXX X000	IPL1 XXXX X000	IPH1 XXXX X111				IPH0 X000 0000	B7h
A8h	IEN0 0000 0000	SADDR 0000 0000						CKCON1 XXXX XXX0	AFh
A0h	P2 1111 1111		AUXR1 0XXX X0X0				WDTRST XXXX XXXX	WDTPRG XXXX X000	A7h
98h	SCON 0000 0000	SBUF XXXX XXXX	BRL 0000 0000	BDRCON XXX0 0000	KBLS 0000 0000	KBE 0000 0000	KBF 0000 0000		9Fh
90h	P1 1111 1111							CKRL 1111 1111	97h
88h	TCON 0000 0000	TMOD 0000 0000	TL0 0000 0000	TL1 0000 0000	TH0 0000 0000	TH1 0000 0000	AUXR XX00 1000	CKCON0 0000 0000	8Fh
80h	P0 1111 1111	SP 0000 0111	DPL 0000 0000	DPH 0000 0000				PCON 00X1 0000	87h
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	

reserved





NIC: Not Internaly Connected

Table 17. CKCON1 Register

CKCON1 - Clock Control Register (AFh)

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	SPIX2

Bit Number	Bit Mnemonic	Description
7	-	**Reserved**
6	-	**Reserved**
5	-	**Reserved**
4	-	**Reserved**
3	-	**Reserved**
2	-	**Reserved**
1	-	**Reserved**
0	SPIX2	**SPI** (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Clear to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.

Reset Value = XXXX XXX0b
Not bit addressable

Reset Output

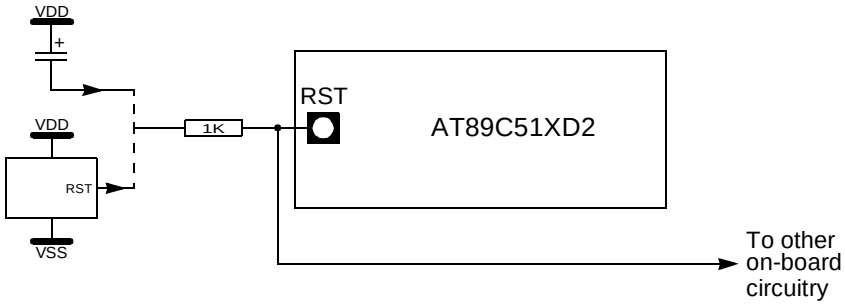
Reset output can be generated by two sources:

- Internal POR/PFD
- Hardware watchdog timer

As detailed in Section “Hardware Watchdog Timer”, page 86, the WDT generates a 96-clock period pulse on the RST pin.

In order to properly propagate this pulse to the rest of the application in case of external capacitor or power-supply supervisor circuit, a 1 kΩ resistor must be added as shown Figure 11.

Figure 11. Recommended Reset Output Schematic



Programmable Counter Array (PCA)

The PCA provides more timing capabilities with less CPU intervention than the standard timer/counters. Its advantages include reduced software overhead and improved accuracy. The PCA consists of a dedicated timer/counter which serves as the time base for an array of five compare/capture modules. Its clock input can be programmed to count any one of the following signals:

- Peripheral clock frequency ($F_{CLK\ PERIPH}$) ÷ 6
- Peripheral clock frequency ($F_{CLK\ PERIPH}$) ÷ 2
- Timer 0 overflow
- External input on ECI (P1.2)

Each compare/capture module can be programmed in any one of the following modes:

- Rising and/or falling edge capture
- Software timer
- High-speed output
- Pulse width modulator

Module 4 can also be programmed as a watchdog timer (see Section "PCA Watchdog Timer", page 47).

When the compare/capture modules are programmed in the capture mode, software timer, or high speed output mode, an interrupt can be generated when the module executes its function. All five modules plus the PCA timer overflow share one interrupt vector.

The PCA timer/counter and compare/capture modules share Port 1 for external I/O. These pins are listed below. If one or several bits in the port are not used for the PCA, they can still be used for standard I/O.

PCA Component	External I/O Pin
16-bit Counter	P1.2/ECI
16-bit Module 0	P1.3/CEX0
16-bit Module 1	P1.4/CEX1
16-bit Module 2	P1.5/CEX2
16-bit Module 3	P1.6/CEX3

The PCA timer is a common time base for all five modules (see Figure 16). The timer count source is determined from the CPS1 and CPS0 bits in the CMOD register (Table 22) and can be programmed to run at:

- 1/6 the peripheral clock frequency ($F_{CLK\ PERIPH}$)
- 1/2 the peripheral clock frequency ($F_{CLK\ PERIPH}$)
- The Timer 0 overflow
- The input on the ECI pin (P1.2)

Serial Port Interface (SPI)

The Serial Peripheral Interface Module (SPI) allows full-duplex, synchronous, serial communication between the MCU and peripheral devices, including other MCUs.

Features

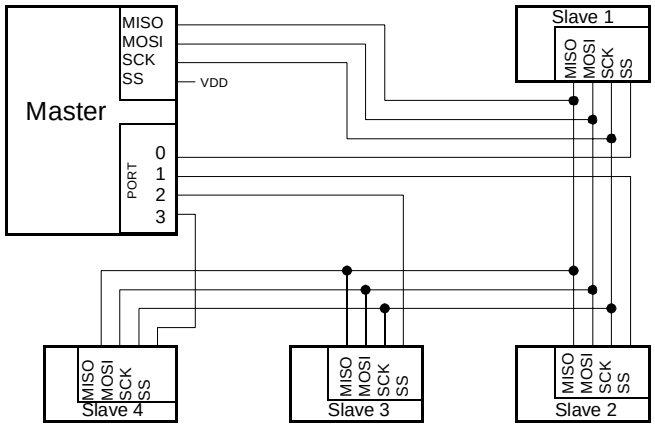
Features of the SPI Module include the following:

- Full-duplex, three-wire synchronous transfers
- Master or Slave operation
- Eight programmable Master clock rates
- Serial clock with programmable polarity and phase
- Master Mode fault error flag with MCU interrupt capability
- Write collision flag protection

Signal Description

Figure 29 shows a typical SPI bus configuration using one Master controller and many Slave peripherals. The bus is made of three wires connecting all the devices.

Figure 29. SPI Master/Slaves Interconnection



The Master device selects the individual Slave devices by using four pins of a parallel port to control the four $\overline{SS}$ pins of the Slave devices.

Master Output Slave Input (MOSI)

This 1-bit signal is directly connected between the Master Device and a Slave Device. The MOSI line is used to transfer data in series from the Master to the Slave. Therefore, it is an output signal from the Master, and an input signal to a Slave. A Byte (8-bit word) is transmitted most significant bit (MSB) first, least significant bit (LSB) last.

Master Input Slave Output (MISO)

This 1-bit signal is directly connected between the Slave Device and a Master Device. The MISO line is used to transfer data in series from the Slave to the Master. Therefore, it is an output signal from the Slave, and an input signal to the Master. A Byte (8-bit word) is transmitted most significant bit (MSB) first, least significant bit (LSB) last.

SPI Serial Clock (SCK)

This signal is used to synchronize the data movement both in and out of the devices through their MOSI and MISO lines. It is driven by the Master for eight clock cycles which allows to exchange one Byte on the serial lines.

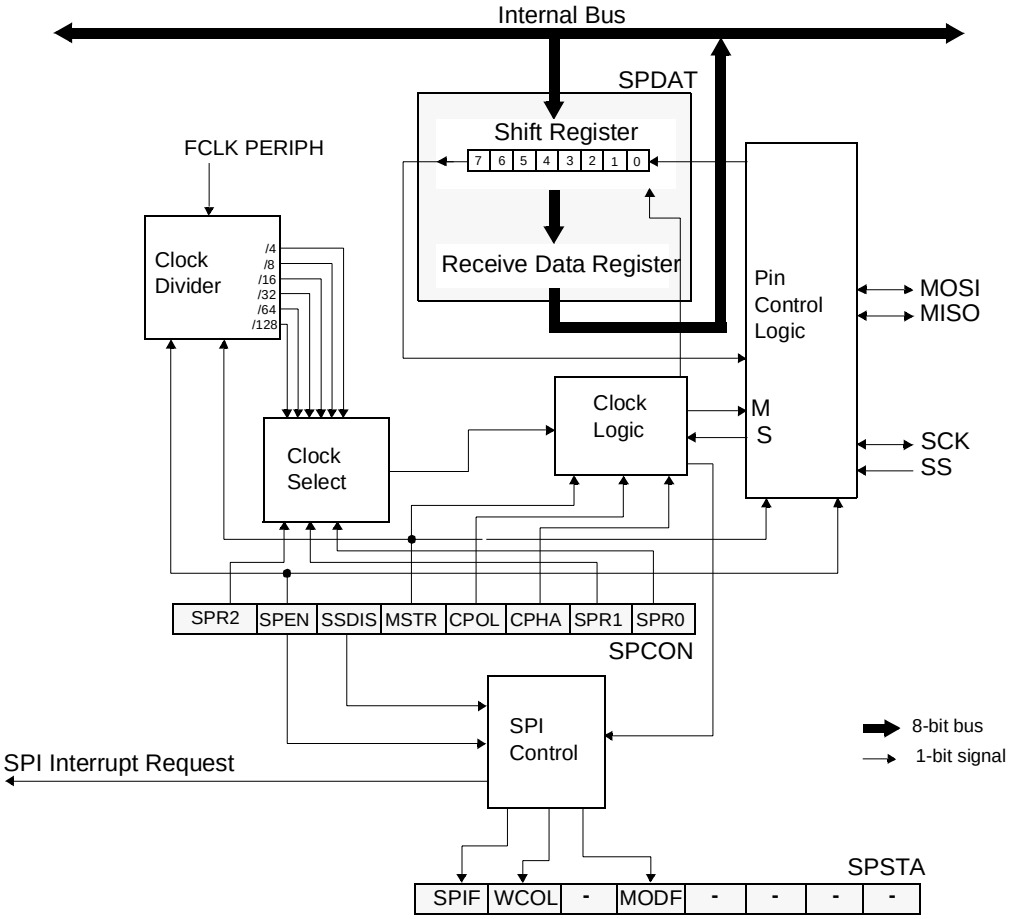
Slave Select ($\overline{SS}$)

Each Slave peripheral is selected by one Slave Select pin ($\overline{SS}$). This signal must stay low for any message for a Slave. It is obvious that only one Master ($\overline{SS}$ high level) can

Functional Description

Figure 30 shows a detailed structure of the SPI Module.

Figure 30. SPI Module Block Diagram



Operating Modes

The Serial Peripheral Interface can be configured in one of the two modes: Master mode or Slave mode. The configuration and initialization of the SPI Module is made through one register:

- The Serial Peripheral Control register (SPCON)

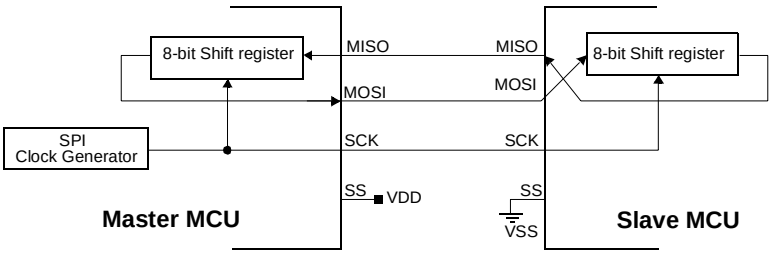
Once the SPI is configured, the data exchange is made using:

- SPCON
- The Serial Peripheral STAtus register (SPSTA)
- The Serial Peripheral DATa register (SPDAT)

During an SPI transmission, data is simultaneously transmitted (shifted out serially) and received (shifted in serially). A serial clock line (SCK) synchronizes shifting and sampling on the two serial data lines (MOSI and MISO). A Slave Select line ($\overline{SS}$) allows individual selection of a Slave SPI device; Slave devices that are not selected do not interfere with SPI bus activities.

When the Master device transmits data to the Slave device via the MOSI line, the Slave device responds by sending data to the Master device via the MISO line. This implies full-duplex transmission with both data out and data in synchronized with the same clock (Figure 31).

Figure 31. Full-Duplex Master-Slave Interconnection



Master Mode

The SPI operates in Master mode when the Master bit, MSTR (1), in the SPCON register is set. Only one Master SPI device can initiate transmissions. Software begins the transmission from a Master SPI Module by writing to the Serial Peripheral Data Register (SPDAT). If the shift register is empty, the Byte is immediately transferred to the shift register. The Byte begins shifting out on MOSI pin under the control of the serial clock, SCK. Simultaneously, another Byte shifts in from the Slave on the Master's MISO pin. The transmission ends when the Serial Peripheral transfer data flag, SPIF, in SPSTA becomes set. At the same time that SPIF becomes set, the received Byte from the Slave is transferred to the receive data register in SPDAT. Software clears SPIF by reading the Serial Peripheral Status register (SPSTA) with the SPIF bit set, and then reading the SPDAT.

Slave Mode

The SPI operates in Slave mode when the Master bit, MSTR (2), in the SPCON register is cleared. Before a data transmission occurs, the Slave Select pin, $\overline{SS}$, of the Slave device must be set to '0'. $\overline{SS}$ must remain low until the transmission is complete.

In a Slave SPI Module, data enters the shift register under the control of the SCK from the Master SPI Module. After a Byte enters the shift register, it is immediately transferred to the receive data register in SPDAT, and the SPIF bit is set. To prevent an overflow condition, Slave software must then read the SPDAT before another Byte enters the shift register (3). A Slave SPI must complete the write to the SPDAT (shift register) at least one bus cycle before the Master SPI starts a transmission. If the write to the data register is late, the SPI transmits the data already in the shift register from the previous transmission. The maximum SCK frequency allowed in slave mode is $F_{CLK\ PERIPH}/4$.

Transmission Formats

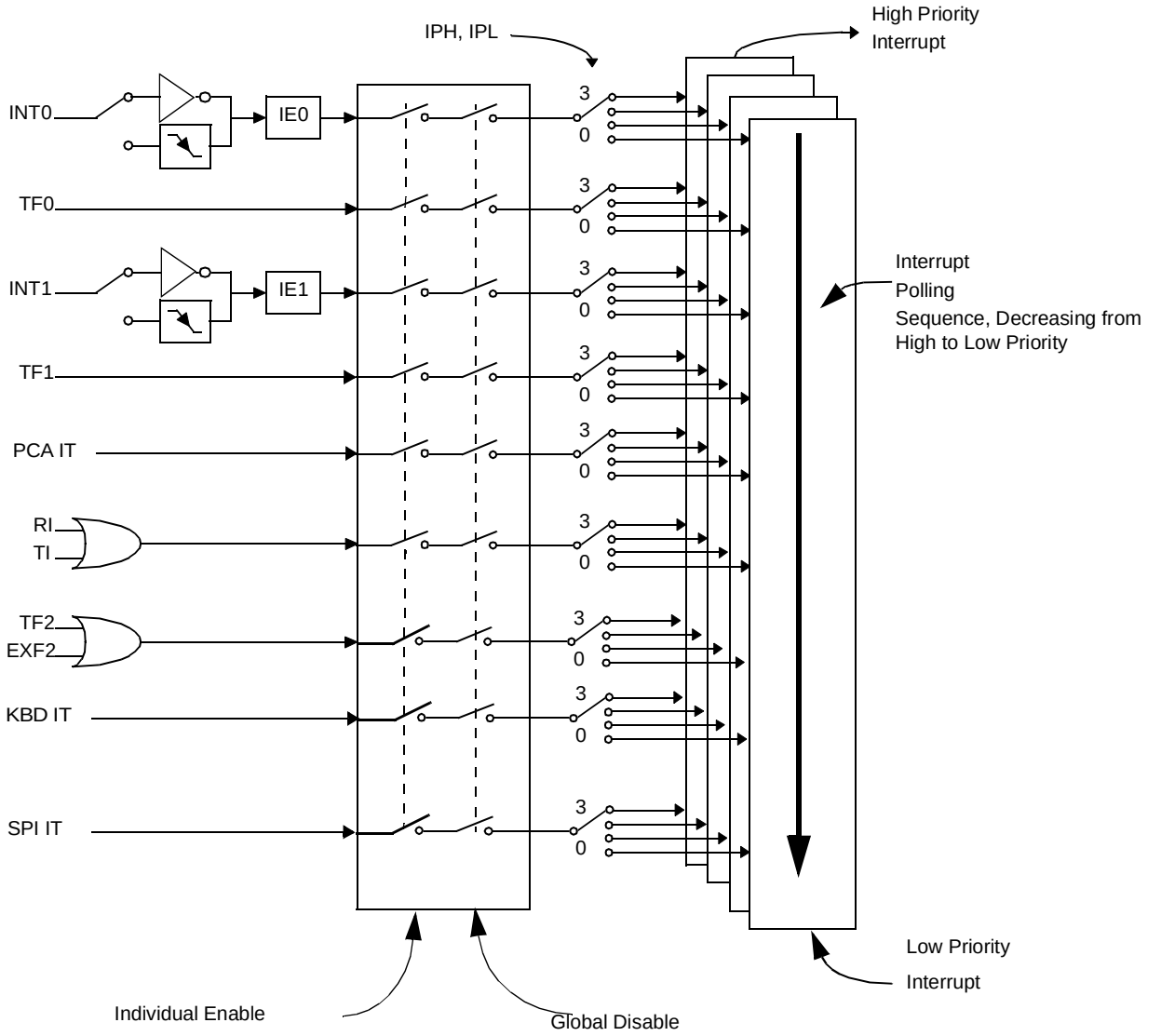
Software can select any of four combinations of serial clock (SCK) phase and polarity using two bits in the SPCON: the Clock Polarity (CPOL (4)) and the Clock Phase (CPHA[4]). CPOL defines the default SCK line level in idle state. It has no significant effect on the transmission format. CPHA defines the edges on which the input data are sampled and the edges on which the output data are shifted (Figure 32 and Figure 33). The clock phase and polarity should be identical for the Master SPI device and the communicating Slave device.

1. The SPI Module should be configured as a Master before it is enabled (SPEN set). Also, the Master SPI should be configured before the Slave SPI.
2. The SPI Module should be configured as a Slave before it is enabled (SPEN set).
3. The maximum frequency of the SCK for an SPI configured as a Slave is the bus clock speed.
4. Before writing to the CPOL and CPHA bits, the SPI should be disabled (SPEN = '0').

Interrupt System

The AT89C51RD2/ED2 has a total of 9 interrupt vectors: two external interrupts ($\overline{INT0}$ and $\overline{INT1}$), three timer interrupts (timers 0, 1 and 2), the serial port interrupt, SPI interrupt, Keyboard interrupt and the PCA global interrupt. These interrupts are shown in Figure 36.

Figure 36. Interrupt Control System



Each of the interrupt sources can be individually enabled or disabled by setting or clearing a bit in the Interrupt Enable register (Table 54 and Table 56). This register also contains a global disable bit, which must be cleared to disable all interrupts at once.

Each interrupt source can also be individually programmed to one out of four priority levels by setting or clearing a bit in the Interrupt Priority register (Table 57) and in the Interrupt Priority High register (Table 55 and Table 56) shows the bit values and priority levels associated with each combination.

Registers

The PCA interrupt vector is located at address 0033H, the SPI interrupt vector is located at address 004BH and Keyboard interrupt vector is located at address 003BH. All other vectors addresses are the same as standard C52 devices.

Table 51. Priority Level Bit Values

IPH.x	IPL.x	Interrupt Level Priority
0	0	0 (Lowest)
0	1	1
1	0	2
1	1	3 (Highest)

A low-priority interrupt can be interrupted by a high priority interrupt, but not by another low-priority interrupt. A high-priority interrupt can't be interrupted by any other interrupt source.

If two interrupt requests of different priority levels are received simultaneously, the request of higher priority level is serviced. If interrupt requests of the same priority level are received simultaneously, an internal polling sequence determines which request is serviced. Thus within each priority level there is a second priority structure determined by the polling sequence.

Interrupt Sources and Vector Addresses

Table 52. Interrupt Sources and Vector Addresses

Number	Polling Priority	Interrupt Source	Interrupt Request	Vector Address
0	0	Reset		0000h
1	1	INT0	IE0	0003h
2	2	Timer 0	TF0	000Bh
3	3	INT1	IE1	0013h
4	4	Timer 1	IF1	001Bh
5	6	UART	RI+TI	0023h
6	7	Timer 2	TF2+EXF2	002Bh
7	5	PCA	CF + CCFn (n = 0 - 4)	0033h
8	8	Keyboard	KBDIT	003Bh
9	9	-	-	0043h
10	10	SPI	SPIIT	004Bh

Table 58. IPH1 Register

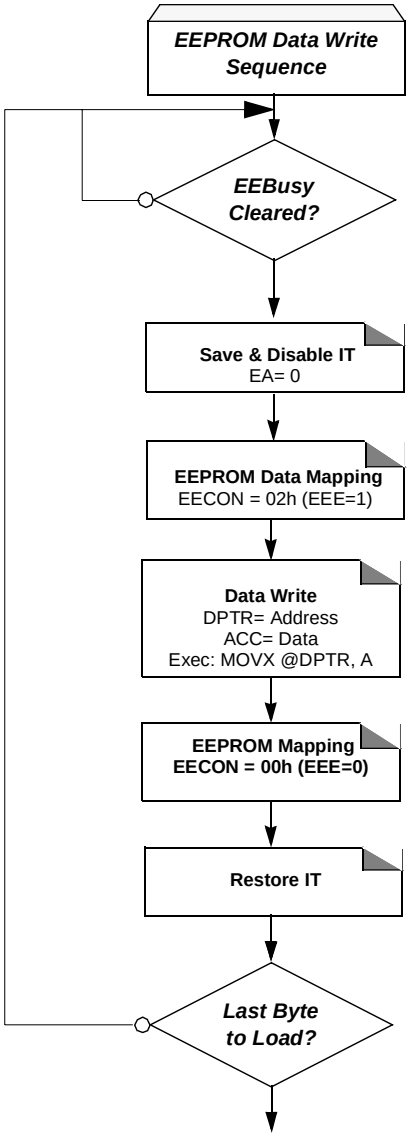
IPH1 - Interrupt Priority High Register (B3h)

7	6	5	4	3	2	1	0
-	-	-	-	-	SPIH	-	KBDH

Bit Number	Bit Mnemonic	Description
7	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
6	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
5	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
4	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
3	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
2	SPIH	**SPI interrupt Priority High bit** SPIH SPIL Priority Level 0 0 Lowest 0 1 1 0 1 1 Highest
1	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
0	KBDH	**Keyboard interrupt Priority High bit** KB DH KBDL Priority Level 0 0 Lowest 0 1 1 0 1 1 Highest

Reset Value = XXXX X000b
Not bit addressable

Figure 38. Recommended EEPROM Data Write Sequence



Flash Registers and Memory Map

The AT89C51RD2/ED2 Flash memory uses several registers for its management:

- Hardware register can only be accessed through the parallel programming modes which are handled by the parallel programmer.
- Software registers are in a special page of the Flash memory which can be accessed through the API or with the parallel programming modes. This page, called "Extra Flash Memory", is not in the internal Flash program memory addressing space.

Hardware Register

The only hardware register of the AT89C51RD2/ED2 is called Hardware Byte or Hardware Security Byte (HSB).

Table 67. Hardware Security Byte (HSB)

7	6	5	4	3	2	1	0
X2	**BLJB**	**-**	**-**	**XRAM**	**LB2**	**LB1**	**LB0**

Bit Number	Bit Mnemonic	Description
7	X2	**X2 Mode** Programmed (‘0’ value) to force X2 mode (6 clocks per instruction) after reset. Unprogrammed (‘1’ Value) to force X1 mode, Standard Mode, after reset (Default).
6	BLJB	**Boot Loader Jump Bit** Unprogrammed (‘1’ value) to start the user’s application on next reset at address 0000h. Programmed (‘0’ value) to start the boot loader at address F800h on next reset (Default).
5	-	**Reserved**
4	-	**Reserved**
3	XRAM	**XRAM config bit (only programmable by programmer tools)** Programmed to inhibit XRAM. Unprogrammed, this bit to valid XRAM (Default).
2-0	LB2-0	**User Memory Lock Bits (only programmable by programmer tools)** See Table 68

Boot Loader Jump Bit (BLJB)

One bit of the HSB, the BLJB bit, is used to force the boot address:

- When this bit is programmed (‘0’ value) the boot address is F800h.
- When this bit is unprogrammed (‘1’ value) the boot address is 0000h.

By default, this bit is programmed and the ISP is enabled.

Flash Memory Lock Bits

The three lock bits provide different levels of protection for the on-chip code and data when programmed as shown in Table 68.

Table 68. Program Lock Bits

Program Lock Bits				
Security Level	**LB0**	**LB1**	**LB2**	**Protection Description**
1	U	U	U	No program lock features enabled.
2	P	U	U	MOVC instruction executed from external program memory is disabled from fetching code bytes from internal memory, $\overline{EA}$ is sampled and latched on reset, and further parallel programming of the on chip code memory is disabled. ISP and software programming with API are still allowed.
3	X	P	U	Same as 2, also verify code memory through parallel programming interface is disabled.
4	X	X	P	Same as 3, also external execution is disabled (Default).

Note: U: Unprogrammed or "one" level.
P: Programmed or "zero" level.
X: Do not care
WARNING: Security level 2 and 3 should only be programmed after Flash and code verification.

These security bits protect the code access through the parallel programming interface. They are set by default to level 4. The code access through the ISP is still possible and is controlled by the "software security bits" which are stored in the extra Flash memory accessed by the ISP firmware.

To load a new application with the parallel programmer, a chip erase must first be done. This will set the HSB in its inactive state and will erase the Flash memory. The part reference can always be read using Flash parallel programming modes.

Default Values

The default value of the HSB provides parts ready to be programmed with ISP:

- BLJB: Programmed force ISP operation.
- X2: Unprogrammed to force X1 mode (Standard Mode).
- XRAM: Unprogrammed to valid XRAM
- LB2-0: Security level four to protect the code from a parallel access with maximum security.

Software Registers

Several registers are used in factory and by parallel programmers. These values are used by Atmel ISP.

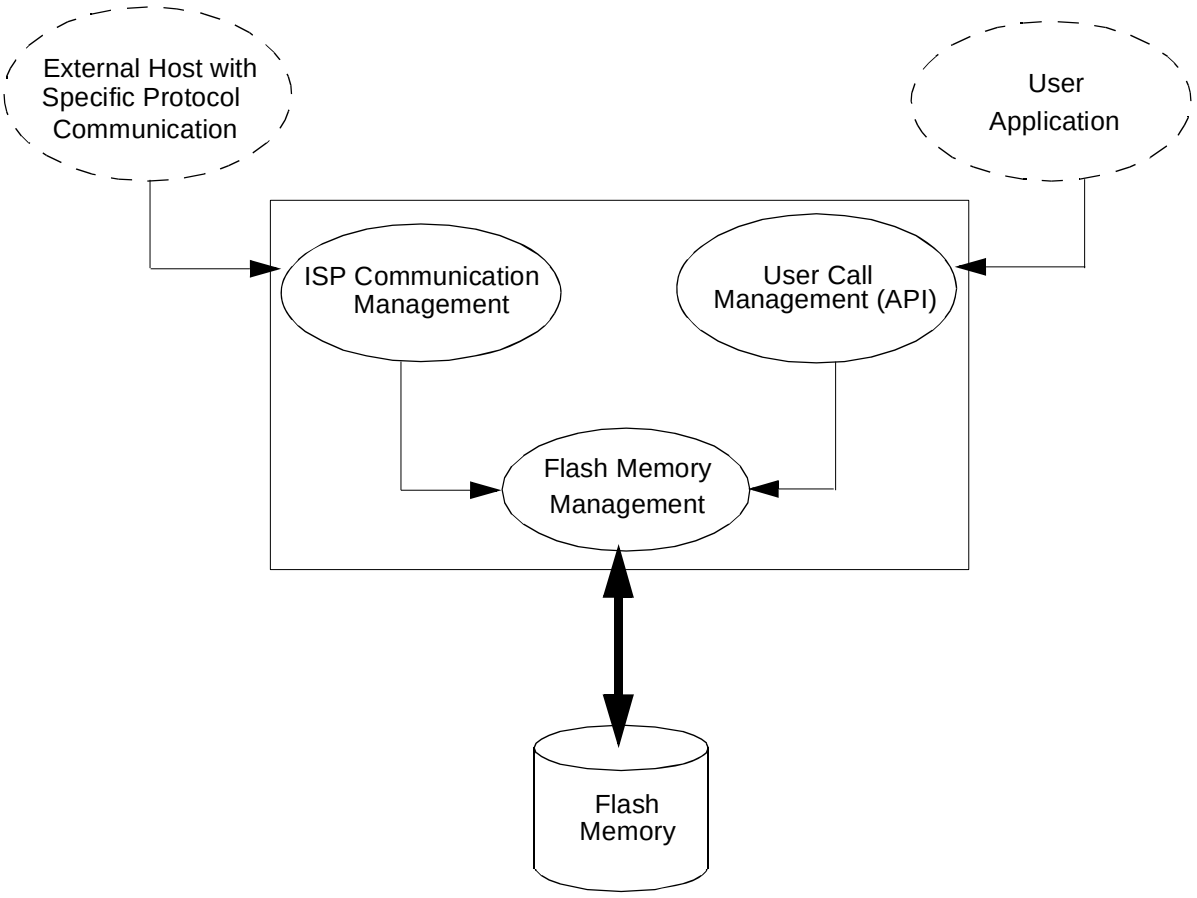
These registers are in the "Extra Flash Memory" part of the Flash memory. This block is also called "XAF" or eXtra Array Flash. They are accessed in the following ways:

- Commands issued by the parallel memory programmer.
- Commands issued by the ISP software.
- Calls of API issued by the application software.

Several software registers are described in Table 69.

Functional Description

Figure 42. Bootloader Functional Description



On the above diagram, the on-chip bootloader processes are:

- ISP Communication Management

The purpose of this process is to manage the communication and its protocol between the on-chip bootloader and a external device. The on-chip ROM implements a serial protocol (see section “Bootloader Protocol”). This process translate serial communication frame (UART) into Flash memory access (read, write, erase, etc.).

- User Call Management

Several Application Program Interface (API) calls are available for use by an application program to permit selective erasing and programming of Flash pages. All calls are made through a common interface (API calls), included in the ROM bootloader. The programming functions are selected by setting up the microcontroller’s registers before making a call to a common entry point (0xFFF0). Results are returned in the registers. The purpose on this process is to translate the registers values into internal Flash Memory Management.

- Flash Memory Management

This process manages low level access to Flash memory (performs read and write access).

Table 76. API Call Summary (Continued)

Command	R1	A	DPTR0	DPTR1	Returned Value	Command Effect
PROGRAM SSB	05h	XXh	DPH = 00h DPL = 00h	00h	ACC = SSB value	Set SSB level 1
			DPH = 00h DPL = 01h			Set SSB level 2
			DPH = 00h DPL = 10h			Set SSB level 0
			DPH = 00h DPL = 11h			Set SSB level 1
PROGRAM BSB	06h	New BSB value	0000h	XXh	none	Program boot status byte
PROGRAM SBV	06h	New SBV value	0001h	XXh	none	Program software boot vector
READ SSB	07h	XXh	0000h	XXh	ACC = SSB	Read Software Security Byte
READ BSB	07h	XXh	0001h	XXh	ACC = BSB	Read Boot Status Byte
READ SBV	07h	XXh	0002h	XXh	ACC = SBV	Read Software Boot Vector
PROGRAM DATA PAGE	09h	Number of byte to program	Address of the first byte to program in the Flash memory	Address in XRAM of the first data to program	ACC = 0: DONE	Program up to 128 bytes in user Flash. Remark: number of bytes to program is limited such as the Flash write remains in a single 128 bytes page. Hence, when ACC is 128, valid values of DPL are 00h, or, 80h.
PROGRAM X2 FUSE	0Ah	Fuse value 00h or 01h	0008h	XXh	none	Program X2 fuse bit with ACC
PROGRAM BLJB FUSE	0Ah	Fuse value 00h or 01h	0004h	XXh	none	Program BLJB fuse bit with ACC
READ HSB	0Bh	XXh	XXXXh	XXh	ACC = HSB	Read Hardware Byte
READ BOOT ID1	0Eh	XXh	DPL = 00h	XXh	ACC = ID1	Read boot ID1
READ BOOT ID2	0Eh	XXh	DPL = 01h	XXh	ACC = ID2	Read boot ID2
READ BOOT VERSION	0Fh	XXh	XXXXh	XXh	ACC = Boot_Version	Read bootloader version

T_A = -40°C to +85°C; V_{SS} = 0V;

V_{CC} =2.7V to 5.5V and F = 0 to 40 MHz (both internal and external code execution)

V_{CC} =4.5V to 5.5V and F = 0 to 60 MHz (internal code execution only) (Continued)

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
V_{OH1}	Output High Voltage, port 0, ALE, $\overline{PSEN}$	V_{CC} - 0.3 V_{CC} - 0.7 V_{CC} - 1.5			V V V	V_{CC} = 5V ± 10% I_{OH} = -200 µA I_{OH} = -3.2 mA I_{OH} = -7.0 mA
		0.9 V_{CC}			V	V_{CC} = 2.7V to 5.5V I_{OH} = -10 µA
R_{RST}	RST Pull-down Resistor	50	200[5]	250	kΩ	
I_{IL}	Logical 0 Input Current ports 1, 2, 3, 4 and 5			-50	µA	V_{IN} = 0.45V
I_{LI}	Input Leakage Current			±10	µA	0.45V < V_{IN} < V_{CC}
I_{TL}	Logical 1 to 0 Transition Current, ports 1, 2, 3, 4			-650	µA	V_{IN} = 2.0V
C_{IO}	Capacitance of I/O Buffer			10	pF	F_C = 3 MHz T_A = 25°C
I_{PD}	Power-down Current		75	150	µA	2.7 < V_{CC} < 5.5V[3]
I_{CCOP}	Power Supply Current on normal mode			0.4 x Frequency (MHz) + 5	mA	V_{CC} = 5.5V[1]
I_{CCIDLE}	Power Supply Current on idle mode			0.3 x Frequency (MHz) + 5	mA	V_{CC} = 5.5V[2]
$I_{CCWRITE}$	Power Supply Current on flash or EEdata write			0.8 x Frequency (MHz) + 15	mA	V_{CC} = 5.5V
t_{WRITE}	Flash or EEdata programming time	7		17	ms	2.7 < V_{CC} < 5.5V
VPFDM	Internal POR/PFD VPFDM threshold	2.25	2.5	2.69	V	
VPFDP	Internal POR/PFD VPFDP threshold	2.15	2.35	2.62	V	
Vhyst	Internal POR/PFD Hysteresys	70	140	250	mV	
Vcc dV/dt	Maximum Vcc Power supply slew rate[7]			0.1	V/µs	

Notes:
1. Operating I_{CC} is measured with all output pins disconnected; XTAL1 driven with T_{CLCH}, T_{CHCL} = 5 ns (see Figure 55), V_{IL} = V_{SS} + 0.5V, V_{IH} = V_{CC} - 0.5V; XTAL2 N.C.; $\overline{EA}$ = RST = Port 0 = V_{CC}. I_{CC} would be slightly higher if a crystal oscillator used (see Figure 52).
2. Idle I_{CC} is measured with all output pins disconnected; XTAL1 driven with T_{CLCH}, T_{CHCL} = 5 ns, V_{IL} = V_{SS} + 0.5V, V_{IH} = V_{CC} - 0.5V; XTAL2 N.C; Port 0 = V_{CC}; $\overline{EA}$ = RST = V_{SS} (see Figure 53).
3. Power-down I_{CC} is measured with all output pins disconnected; $\overline{EA}$ = V_{SS}, PORT 0 = V_{CC}; XTAL2 NC.; RST = V_{SS} (see Figure 54).
4. Capacitance loading on Ports 0 and 2 may cause spurious noise pulses to be superimposed on the V_{OLS} of ALE and Ports 1 and 3. The noise is due to external bus capacitance discharging into the Port 0 and Port 2 pins when these pins make 1 to 0 transitions during bus operation. In the worst cases (capacitive loading 100 pF), the noise pulse on the ALE line may exceed 0.45V with maxi V_{OL} peak 0.6V. A Schmitt Trigger use is not necessary.
5. Typical values are based on a limited number of samples and are not guaranteed. The values listed are at room temperature and 5V.
6. Under steady state (non-transient) conditions, I_{OL} must be externally limited as follows:
   Maximum I_{OL} per port pin: 10 mA
   Maximum I_{OL} per 8-bit port:
   Port 0: 26 mA
   Ports 1, 2 and 3: 15 mA

Datasheet Change Log for AT89C51RD2/ED2

Changes from 4235A - 04/03 to 4135B - 06/03

1. V_{IH} min changed from 0.2 V_{CC} + 1.1 to 0.2 V_{CC} + 0.9.
2. Added POR/PFD and reset specific sections.
3. Added DIL40 package.
4. Added Flash write programming time specification.

Changes from 4235B - 06/03 to 4235C - 08/03

1. Changed maximum frequency to 60 MHz in X1 mode and 30 MHz in X2 mode for Vcc = 4.5V to 5.5V and internal code execution.
2. Added PDIL40 Packaging for AT89C51ED2.

Changes from 4235C - 08/03 to 4235D - 12/03

1. Improved explanations throughout the document.

Changes from 4235D - 12/03 to 4235E - 04/04

1. Improved explanations throughout the document.

Changes from 4235E - 04/04 to 4235F - 09/04

1. Improved explanations in Flash and EEPROM sections.

Changes from 4235F - 09/04 to 4235G 08/05

1. Added ‘Industrial & Green” product versions.

Changes from 4235G 08/05 to 4235H - 10/06

1. Correction to PDIL figure on page 9.

Atmel Corporation

2325 Orchard Parkway
San Jose, CA 95131, USA
Tel: 1(408) 441-0311
Fax: 1(408) 487-2600

Regional Headquarters

Europe
Atmel Sarl
Route des Arsenaux 41
Case Postale 80
CH-1705 Fribourg
Switzerland
Tel: (41) 26-426-5555
Fax: (41) 26-426-5500

Asia
Room 1219
Chinachem Golden Plaza
77 Mody Road Tsimshatsui
East Kowloon
Hong Kong
Tel: (852) 2721-9778
Fax: (852) 2722-1369

Japan
9F, Tonetsu Shinkawa Bldg.
1-24-8 Shinkawa
Chuo-ku, Tokyo 104-0033
Japan
Tel: (81) 3-3523-3551
Fax: (81) 3-3523-7581

Atmel Operations

Memory
2325 Orchard Parkway
San Jose, CA 95131, USA
Tel: 1(408) 441-0311
Fax: 1(408) 436-4314

Microcontrollers
2325 Orchard Parkway
San Jose, CA 95131, USA
Tel: 1(408) 441-0311
Fax: 1(408) 436-4314

La Chantrerie
BP 70602
44306 Nantes Cedex 3, France
Tel: (33) 2-40-18-18-18
Fax: (33) 2-40-18-19-60

ASIC/ASSP/Smart Cards
Zone Industrielle
13106 Rousset Cedex, France
Tel: (33) 4-42-53-60-00
Fax: (33) 4-42-53-60-01

1150 East Cheyenne Mtn. Blvd.
Colorado Springs, CO 80906, USA
Tel: 1(719) 576-3300
Fax: 1(719) 540-1759

Scottish Enterprise Technology Park
Maxwell Building
East Kilbride G75 0QR, Scotland
Tel: (44) 1355-803-000
Fax: (44) 1355-242-743

RF/Automotive
Theresienstrasse 2
Postfach 3535
74025 Heilbronn, Germany
Tel: (49) 71-31-67-0
Fax: (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd.
Colorado Springs, CO 80906, USA
Tel: 1(719) 576-3300
Fax: 1(719) 540-1759

Biometrics/Imaging/Hi-Rel MPU/
High Speed Converters/RF Datacom
Avenue de Rochepleine
BP 123
38521 Saint-Egreve Cedex, France
Tel: (33) 4-76-58-30-00
Fax: (33) 4-76-58-34-80

Literature Requests
www.atmel.com/literature

A–8051–10/06